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MDOB256064D1Y-WS	256	6 x 64	OLED Module		
Specification					
Version: 1		-	Date: 26/10/2019		
	Revision				
1	23/10/2019	First	Issue		

Display F				
Resolution	256 x 64			
Appearance	White on Black			
Logic Voltage	3.3V ROHS		ЮНЭ	
Interface	SPI	CO	ompliant	
Module Size	70.0 x 22.0 x 1.71mm			
Operating Temperature	-40°C ~ +80°C	Box Quantity	Weight / Display	
Construction	СОВ			

\* - For full design functionality, please use this specification in conjunction with the SSD1362 specification. (Provided Separately)

Displ	Display Accessories					
Part Number	Description	AC				

Optional Variants				
Appearance	Voltage			

# **General Specification**

The Features is described as follow:

■ Module dimension: 70.0 x 22.0 x 1.71mm

■ Active area: 51.18 x 12.78mm

■ Dot Matrix: 256 x 64 Dots

■ Pixel Size: 0.18 x 0.18 mm

■ Pixel Pitch: 0.20 x 0.20 mm

■ Display Mode: Passive Matrix

■ Duty: 1/64 Duty

■ Gray Scale: 4 Bits

■ Display Color: White

■ IC: SSD1362

■ Interface: SPI

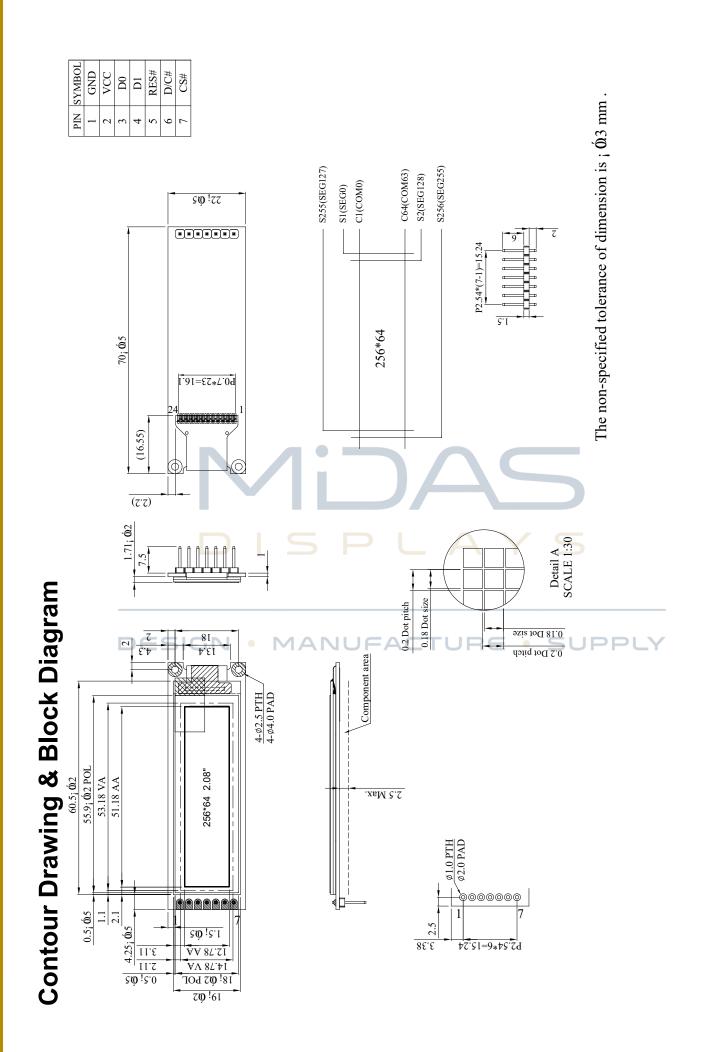
■ Size: 2.08 inch

DISPLAYS

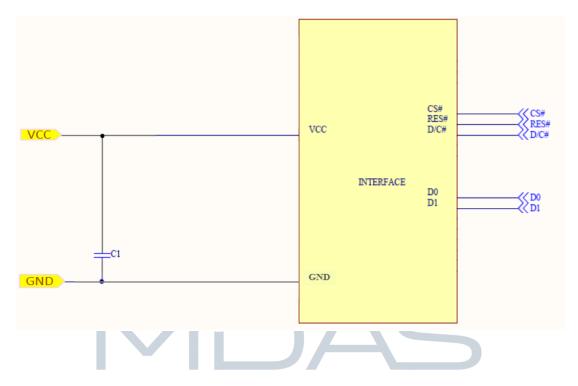
## **Interface Pin Function**

No.	Symbol	Function
1	GND	Reserved pin. It should be connected to ground.
2	VCC	Power supply for panel driving voltage. This is also the most positive power voltage supply pin. It is supplied by external high voltage source.
3	D0	These pins are bi-directional data bus connecting to the MCU data bus. Unused pins are recommended to tie LOW.
4	D1	When serial interface mode is selected, D0 will be the serial clock input: SCLK; D1 will be the serial data input: SID.
5	RES#	This pin is reset signal input. When the pin is pulled LOW, initialization of the chip is executed. Keep this pin pull HIGH during normal operation.
6	D/C#	This pin is Data/Command control pin connecting to the MCU. When the pin is pulled HIGH, the data at D[1:0] will be interpreted as data. When the pin is pulled LOW, the data at D[1:0] will be transferred to a command register.
7	CS#	This pin is the chip select input connecting to the MCU. The chip is enabled for MCU communication only when CS# is pulled LOW (active LOW).

### DISPLAYS



## **Application recommendations**



Recommended components:

C1: 4.7uF

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### Note

(1) The capacitor value is recommended value. Select appropriate value against module application.

## **Absolute Maximum Ratings**

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage	VCC	1.65	5.5	V	1,2
Operating Temperature	TOP	-40	+80	°C	_
Storage Temperature	TSTG	-40	+85	°C	_

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6. "Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

# **Electrical Characteristics**

### **DC Electrical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage	VCC	_	2.8	3.3	5.2	٧
Input High Volt.	VIH	IUFACTU	0.8×VCC	SU	PACCA	٧
Input Low Volt.	VIL	_	0	_	0.2×VCC	٧
Output High Volt.	VOH	_	0.9×VCC	_	VCC	٧
Output Low Volt.	VOL	_	0	_	0.1×VCC	٧
50% Check Board operating Current	ICC	VCC=3.3V	_	90	135	mA

### Initial code

```
void Initial SSD1362()
{
    LCM CS1=0;
Write command(0XFD); //Set Command Lock
Write command(0X12); //(12H=Unlock,16H=Lock)
Write command(0XAE); //Display OFF(Sleep Mode)
Write command(0X15); //Set column Address
Write command(0X00); //Start column Address
Write command(0X7F); //End column Address
Write command(0X75); //Set Row Address
Write command(0X00); //Start Row Address
Write command(0X3F); //End Row Address
Write command(0X81); //Set contrast
Write command(0x2f);
Write command(0XA0); //Set Remap
Write command(0Xc3);
Write command(0XA1); //Set Display Start Line
Write command(0X00);
Write command(0XA2); //Set Display Offset
Write command(0X00);
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Write command(0XA4); //Normal Display
Write command(0XA8); //Set Multiplex Ratio
Write command(0X3F);
Write command(0XAB); //Set VDD regulator
Write command(0X01); //Regulator Enable
Write command(0XAD); //External /Internal IREF Selection
Write command(0X8E);
Write command(0XB1); //Set Phase Length
Write command(0X22);
Write command(0XB3); //Display clock Divider
Write command(0XA0);
Write command(0XB6); //Set Second pre-charge Period
Write command(0X04);
```

Write\_command(0XB9); //Set Linear LUT

Write\_command(0XBc); //Set pre-charge voltage level
Write\_command(0X10); //0.5\*Vcc

Write\_command(0XBD); //Pre-charge voltage capacitor Selection
Write\_command(0X01);

Write\_command(0XBE); //Set COM deselect voltage level
Write\_command(0X07); //0.82\*Vcc

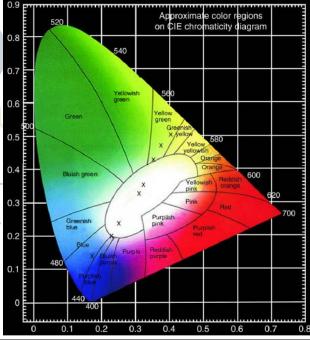
Write\_command(0XAF); //Display ON
}



# **Optical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
Viou Anglo	(V)θ	_	160	_	_	deg
View Angle	(Η)φ	_	160	_	_	deg
Contrast Ratio	CR	Dark	2000:1	_	_	_
Doonongo Timo	T rise	_	_	10	_	μs
Response Time	T fall	_	_	10	_	μs
Display with 100% check Board Brightness			80	100	_	cd/m2
CIEx(Wh	ite)	(CIE1931)	0.26	0.28	0.30	_
CIEy(Wh	ite)	(CIE1931)	0.30	0.32	0.34	_





### **OLED Lifetime**

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°C / Initial 50% check board brightness Typical Value	20,000 Hrs	-	Note

#### Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.

# Reliability

**Content of Reliability Test** 

Environmenta	l Test		
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	85°C 240hrs	
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C 240hrs	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80°C 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40°C 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90%RH 240hrs	
High Temperature/ Humidity Operation	Endurance test applying the high temperature and high humidity Operation for a long time.	60°C,90%RH 120hrs	5
Temperature Cycle Mechanical Tes	Endurance test applying the low and high temperature cycle.  -40°C 25°C 80°C  30min 5min 30min 1 cycle	-40°C /80°C 30 cycles	 SUPPLY
Vibration test	Endurance test applying the vibration during transportation and using.	Frequency:10~55Hz amplitude:1.5mm Time:0.5hrs/axis Test axis:X,Y,Z	
Others			
Static electricity test	Endurance test applying the electric stress to the finished product housing.	Air Discharge model ±4kv,10 times	

<sup>\*\*\*</sup> Supply voltage for OLED system =Operating voltage at 25°C

#### Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels on/off exchange is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

#### **Evaluation criteria**

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

#### **APPENDIX:**

#### **RESIDUE IMAGE**

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



## Inspection specification

### **Inspection Standard:**

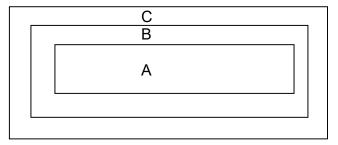
MIL-STD-105E table normal inspection single sample level II.

#### **Definition**

1 Major defect: The defect that greatly affect the usability of product.

 $\ensuremath{\mathsf{2}}$  Minor defect : The other defects, such as cosmetic defects, etc.

Definition of inspection zone:



Zone A: Active Area

Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer's product.

### **Inspection Methods**

1 The general inspection: Under fluorescent light illumination: 750~1500 Lux, about 30cm viewing distance, within 45° viewing angle, under 25±5°C.

2 The luminance and color coordinate inspection: By SR-3 or BM-7 or the equal equipments, in the dark room, under 25±5°C.

NO	Item	Criterion	AQL
01	Electrical Testing	<ul> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 OLED viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ul>	0.65
02	Black or white spots on OLED (display only)	<ul> <li>2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li> <li>2.2 Densely spaced: No more than two spots or lines within 3mm.</li> </ul>	2.5

NO	Item		Criterion			AQL
	OLED black spots, white spots, contamin ation (non-display)	3.1 Round type : As following drawing Φ=(x+y)/2  → X	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable QTY Accept no dense 2 1 0	Zone A+ B, A+ B A+ B A+ B	2.5
03		3.2 Line type : (As for the latest type : (	Width W≤0.02 0.02 <w≤0.00< td=""><td></td><td>Zone A+B A+B A+B</td><td>2.5</td></w≤0.00<>		Zone A+B A+B A+B	2.5
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	Size $\Phi$ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense  3 2 0 3	Zone A+B A+B A+B A+B	2.5
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination.				

NO	Item	Criterion		
	Chipped glass	Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length: 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:  z: Chip thickness y: Chip width x: Chip length		
		⊙ If there are 2 or more chips, x is total length of each chip.		
06		6.1.2 Corner crack:    z: Chip thickness y: Chip width x: Chip length $Z \le 1/2t$ Not over viewing area $x \le 1/8a$ $1/2t < z \le 2t$ Not exceed $1/3k$ $x \le 1/8a$ $\odot$ If there are 2 or more chips, x is the total length of each chip.	2.5	
	Glass crack	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		

NO	Item	Criterion	
06	Glass crack	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	2.5
07	Cracked glass	The OLED with extensive crack is not acceptable.	
08	Backlight elements	8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong.	
09	Bezel	<ul><li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li><li>9.2 Bezel must comply with job specifications.</li></ul>	

NO	Item	Criterion	AQL
10	PCB, COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		<ul><li>10.2 COB seal surface may not have pinholes through to the IC.</li><li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li></ul>	2.5 0.65
		10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than	2.5
		three places.  10.5 No oxidation or contamination PCB terminals.  10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.	2.5 0.65
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation	2.5 2.5
		or icicle.  11.3 No residue or solder balls on PCB.  11.4 No short circuits in components on PCB.	2.5 0.65
	General appearance	12.1 No oxidation, contamination, curves or, bends on interface	2.5
12		Pin (OLB) of TCP.  12.2 No cracks on interface pin (OLB) of TCP.  12.3 No contamination, solder residue or solder balls on	0.65 2.5
		product.  12.4 The IC on the TCP may not be damaged, circuits.  12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to	2.5 2.5
		sever.  12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.	2.5
		<ul><li>12.7 Sealant on top of the ITO circuit has not hardened.</li><li>12.8 Pin type must match type in specification sheet.</li></ul>	2.5 0.65
		12.9 OLED pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	0.65

Check Item	Classification	Criteria	
No Display	Major		
Missing Line	Major		
Pixel Short	Major		
Darker Short	<b>M</b> ajor		
Wrong Display	ANU <sub>Major</sub> CTU	JR HERE	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	A Normal B Dark Fixel C E Light Fixel	

### **Precautions in use of OLED Modules**

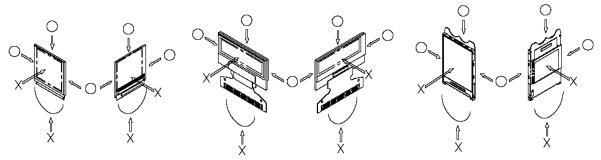
- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, change the components or modify its shape of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Do not apply input signals while the logic power is off.
- (5) Don't operate it above the absolute maximum rating.
- (6) Don't drop, bend or twist OLED display module.
- (7) Soldering: only to the I/O terminals.
- (8) Hot-Bar FPC soldering condition: 280~350C, less than 5 seconds.
- (9) Midas has the right to change the passive components (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.) and change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Midas have the right to modify the version.)
- (10) Midas has the right to upgrade or modify the product function.

### 1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged. So, be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalent
  - Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- \* Water
- \* Ketone
- \* Aromatic Solvents
- (6) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (7) Do not touch the following sections whenever possible while handling the OLED display modules.
  - \* Pins and electrodes
  - \* Pattern layouts such as the TCP & FPC
- (8) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- (9) Do not apply stress to the LSI chips and the surrounding molded sections.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
  - \* Be sure to make human body grounding when handling OLED display modules.
  - \* Be sure to ground tools to use or assembly such as soldering irons.
  - \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
  - \* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

#### 2. Storage Precautions

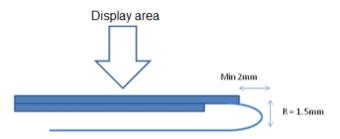
- (1) When storing OLED display modules, put them in static electricity preventive bags to avoid be directly exposed to sun or lights of fluorescent lamps. (We recommend you to store these modules in the packaged state when they were shipped from Midas. At that time, be careful not to let water drops adhere to the packages or bags.)
- (2) When the OLED display module is being dewed or when it is placed under high temperature or high humidity environments, the electrodes may be corroded if electric current is applied. Please store it in clean environment.

#### 3. Designing Precautions

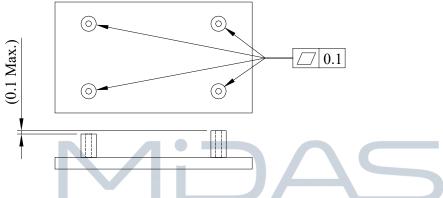
- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, OLED display module may be damaged.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specification and to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD / VCC). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the nearby devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) If the power supplied to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
  - \* Connection (contact) to any other potential than the above may lead to rupture of the IC.
- (7) If this OLED driver is exposed to light, malfunctioning may occur and semiconductor elements may change their characteristics.
- (8) The internal status may be changed, if excessive external noise enters into the module. Therefore, it is necessary to take appropriate measures to suppress noise generation or to protect module from influences of noise on the system design.
- (9) We recommend you to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (10) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use the same

image for long time in real application. When an OLED display module is operated for a long of time with fixed pattern, an afterimage or slight contrast deviation may occur.

(11) The limitation of FPC and Film bending.



(12) The module should be fixed balanced into the housing, or the module may be twisted.



### 4. Precautions when disposing of the OLED display modules

(1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.